

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 20277
Shiroshi MATSUKI, et al. : Confirmation Number: 9915
Application No.: 09/944,344 : Group Art Unit: 1753
Filed: September 04, 2001 : Examiner: Edna Wong

For: MATERIAL FOR COPPER ELECTROPLATING, METHOD FOR MANUFACTURING SAME AND COPPER ELECTROPLATING METHOD

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Transmitted herewith is an Amendment in the above-identified application.

- ☒ No additional fee is required.
☐ Applicant is entitled to small entity status under 37 CFR 1.27
☐ Also attached:

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	17	20	0	\$50.00 =	\$0.00
Independent Claims	8	8	0	\$200.00 =	\$0.00
Multiple dependent claims newly presented					\$0.00
Fee for extension of time					\$0.00
					\$0.00
Total of Above Calculations					\$0.00

- ☐ Please charge my Deposit Account No. 500417 in the amount of \$0.00. An additional copy of this transmittal sheet is submitted herewith.
- ☒ The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 500417, including any filing fees under 37 CFR 1.16 for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,

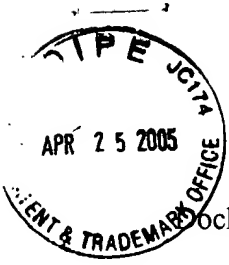
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Date: April 25, 2005

Please recognize our Customer No. 20277
as our correspondence address.

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ocket No.: 050352-0020

PATENT

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AMENDMENT and REQUEST FOR RECONSIDERATION
UNDER 37 CFR § 1.111

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This is a response to the non-final Office Action dated January 25, 2005. The above-referenced patent application has been amended as set forth below.

Please amend claim 1 as set forth in the "Amendments to the Claims" on pages 2 to 5 of this response.